

Welcome to [E-XFL.COM](#)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Not For New Designs
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	520
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100e-5fn1152c

sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

3. Left and Right (Banks 2, 3, 6 and 7) sysl/O Buffer Pairs (50% Differential and 100% Single-Ended Outputs)

The sysl/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. One of the referenced input buffers can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

LVDS differential output drivers are available on 50% of the buffer pairs on the left and right banks.

4. Bank 8 sysl/O Buffer Pairs (Single-Ended Outputs, Only on Shared Pins When Not Used by Configuration)

The sysl/O buffers in Bank 8 consist of single-ended output drivers and single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

In LatticeECP2 devices, only the I/Os on the bottom banks have programmable PCI clamps. In LatticeECP2M devices, the I/Os on the left and bottom banks have programmable PCI clamps.

Typical sysl/O I/O Behavior During Power-up

The internal power-on-reset (POR) signal is deactivated when V_{CC} , V_{CCIO8} and V_{CCAUX} have reached satisfactory levels. After the POR signal is deactivated, the FPGA core logic becomes active. It is the user's responsibility to ensure that all other V_{CCIO} banks are active with valid input logic levels to properly control the output logic states of all the I/O banks that are critical to the application. For more information about controlling the output logic state with valid input logic levels during power-up in LatticeECP2/M devices, see the list of additional technical documentation at the end of this data sheet.

The V_{CC} and V_{CCAUX} supply the power to the FPGA core fabric, whereas the V_{CCIO} supplies power to the I/O buffers. In order to simplify system design while providing consistent and predictable I/O behavior, it is recommended that the I/O buffers be powered-up prior to the FPGA core fabric. V_{CCIO} supplies should be powered-up before or together with the V_{CC} and V_{CCAUX} supplies.

Prior to and throughout programming of the FPGA, the I/O of the device have a weak-pullup resistor to V_{CCIO} on the input buffer and the output buffer is tri-stated. A pullup to V_{CCIO} is present on the input until the user programs the input differently in the FPGA design. See the [DC Electrical Characteristics](#) table of this data sheet. The pullup value will be between 20-30K ohms based on the V_{CCIO} voltage supplied on the board. This pullup will also remain active if the design does not use a particular I/O.

Supported sysl/O Standards

The LatticeECP2/M sysl/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTL and other standards. The buffers support the LVTTL, LVCMOS 1.2V, 1.5V, 1.8V, 2.5V and 3.3V standards. In the LVCMOS and LVTTL modes, the buffer has individual configuration options for drive strength, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL and HSTL. Differential standards supported include LVDS, MLVDS, BLVDS, LVPECL, RSDDS, differential SSTL and differential HSTL. Tables 2-13 and 2-14 show the I/

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5 ¹	13.0	45.0	2.5 ¹
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

SERDES Power Supply Requirements (LatticeECP2M Family Only)¹

Over Recommended Operating Conditions

Symbol	Description	Typ. ²	Units
Standby (Power Down)			
I _{CCTX-SB}	V _{CCTX} current (per channel)	10	µA
I _{CCRX-SB}	V _{CCRX} current (per channel)	75	µA
I _{CCIB-SB}	Input buffer current (per channel)	0	µA
I _{CCOB-SB}	Output buffer current (per channel)	0	µA
I _{CCP-SB}	SERDES PLL current (per quad)	30	µA
I _{CCAX33-SB}	SERDES termination current (per quad)	10	µA
Operating (Data Rate = 3.125 Gbps)			
I _{CCTX-OP}	V _{CCTX} current (per channel)	19	mA
I _{CCRX-OP}	V _{CCRX} current (per channel)	34	mA
I _{CCIB-OP}	Input buffer current (per channel)	4	mA
I _{CCOB-OP}	Output buffer current (per channel)	13	mA
I _{CCP-OP}	SERDES PLL current (per quad)	26	mA
I _{CCAX33-OP}	SERDES termination current (per quad)	0.01	mA

1. Equalization enabled, pre-emphasis disabled.

2. T_J = 25°C, power supplies at nominal voltage.

SERDES Power (LatticeECP2M Family Only)

Table 3-1 presents the SERDES power for one channel.

Table 3-1. SERDES Power¹

Symbol	Description	Typ. ²	Units
P _{S-1CH-31}	SERDES power (one channel @ 3.125 Gbps)	90	mW
P _{S-1CH-25}	SERDES power (one channel @ 2.5 Gbps)	87	mW
P _{S-1CH-12}	SERDES power (one channel @ 1.25 Gbps)	86	mW
P _{S-1CH-02}	SERDES power (one channel @ 250 Mbps)	76	mW

1. One quarter of the total quad power (includes contribution from common circuits, all channels in the quad operating, pre-emphasis disabled, equalization enabled).

2. Typical values measured at 25°C and 1.2V.

SERDES External Reference Clock (LatticeECP2M Family Only)

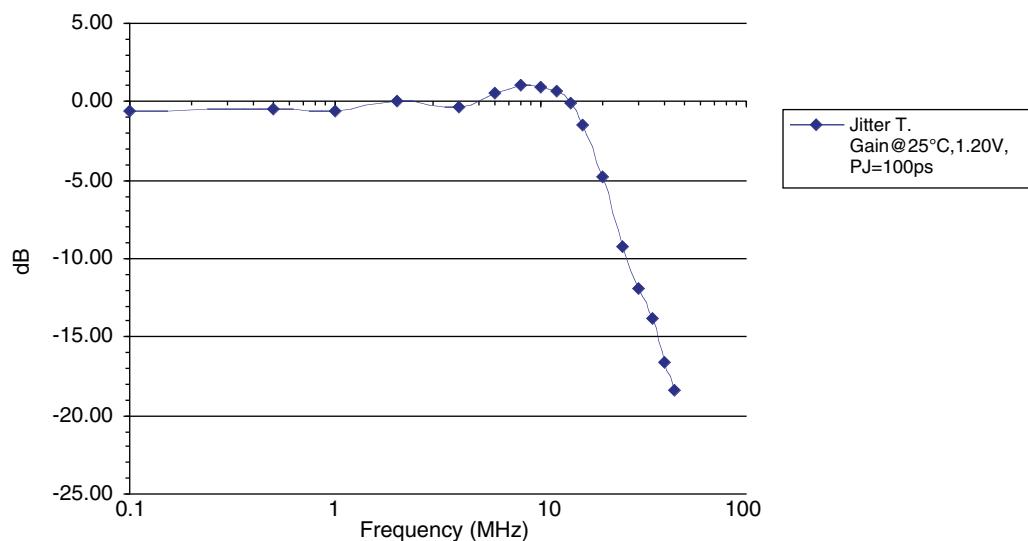
The external reference clock selection and its interface are a critical part of system applications for this product. Table 3-14 specifies reference clock requirements, over the full range of operating conditions.

Table 3-14. External Reference Clock Specification (refclkp/refclkn)

Symbol	Description	Min.	Typ.	Max.	Units
F_{REF}	Frequency range	25	—	320	MHz
$F_{REF-PPM}$	Frequency tolerance	-300	—	300	ppm
$V_{REF-IN-SE}$	Input swing, single-ended clock ¹	100	—	1200	mV, p-p
V_{REF-IN}	Input levels	0	—	$V_{CCP} + 0.8$	V
$V_{REF-CM-DC}$	Input common mode range (DC coupled)	0.5	—	1.2	V
$V_{REF-CM-AC}$	Input common mode range (AC coupled) ²	0	—	1.5	V
D_{REF}	Duty cycle ³	40	—	60	%
T_{REF-R}	Rise time (20% to 80%)		500	1000	ps
T_{REF-F}	Fall time (80% to 20%)		500	1000	ps
$Z_{REF-IN-TERM}$	Input termination		50/2K		Ohms
$C_{REF-IN-CAP}$	Input capacitance ⁴	—	—	1.5	pF

1. The signal swing for a single-ended input clock must be as large as the p-p differential swing of a differential input clock to get the same gain at the input receiver. Lower swings for the clock may be possible, but will tend to increase jitter.
2. When AC coupled, the input common mode range is determined by:
 $(\text{Min input level}) + (\text{Peak-to-peak input swing})/2 \leq (\text{Input common mode voltage}) \leq (\text{Max input level}) - (\text{Peak-to-peak input swing})/2$
3. Measured at 50% amplitude.
4. Input capacitance of 1.5pF is total capacitance, including both device and package.

Figure 3-13. Jitter Transfer



Note: This graph is for a nominal device.

SERDES Power-Down/Power-Up Specification

Table 3-15. Power-Down and Power-Up Specification

Symbol	Description	Max.	Units
t_{PWRDN}	Power-down time after all power down register bits set to '0'	10	μs
t_{PWRUP}	Power-up time after all power down register bits set to '1'	100	μs

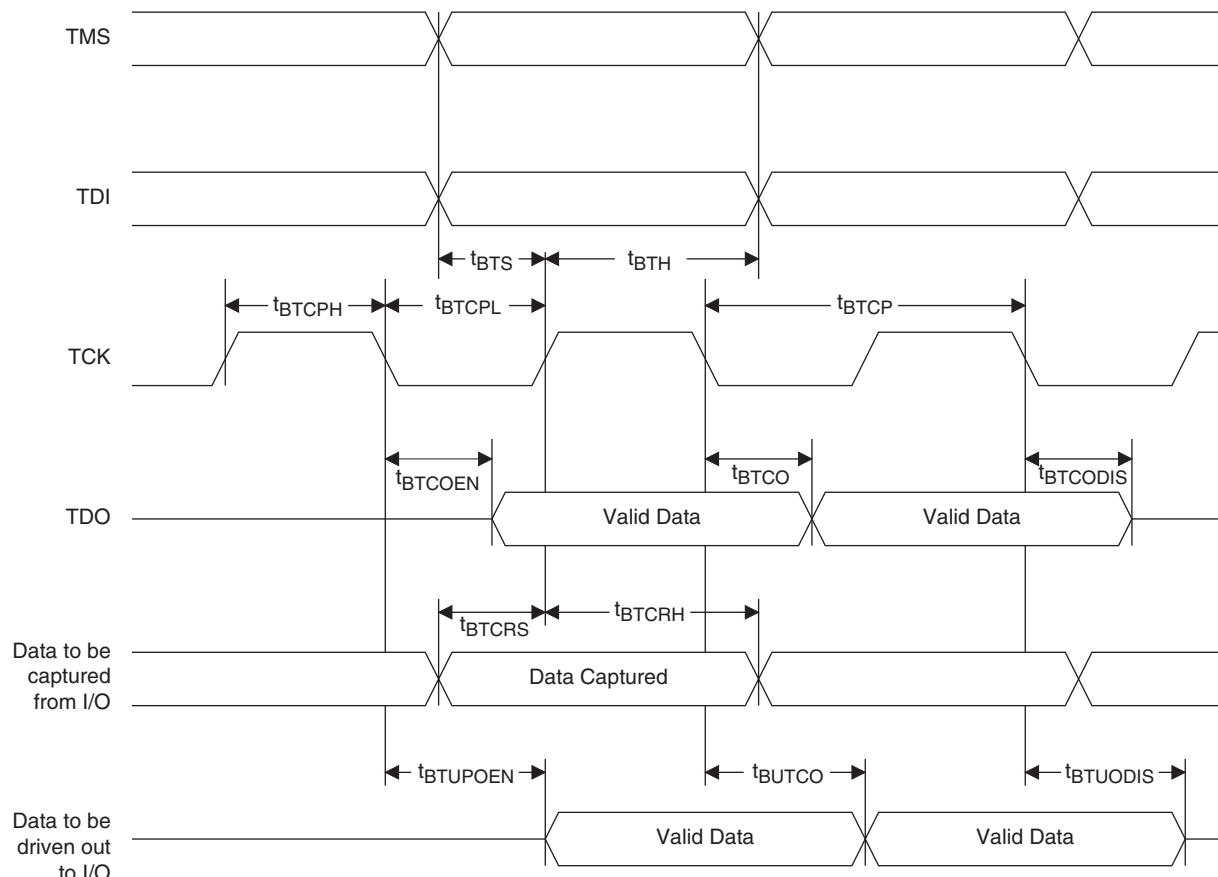
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUOPEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms



LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
R12	GND	-			GND	-			
R5	GND	-			GND	-			
T1	GND	-			GND	-			
T16	GND	-			GND	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for PLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AH24	PB89A	4	BDQ87	T
AH25	PB89B	4	BDQ87	C
VCCIO	VCCIO4	4		
AJ26	PB90A	4	BDQ87	T
AK26	PB90B	4	BDQ87	C
AF25	PB91A	4	BDQ87	T
AG25	PB91B	4	BDQ87	C
GND	GNDIO4	-		
AK22	PB92A	4	BDQ96	T
AJ22	PB92B	4	BDQ96	C
AE22	PB93A	4	BDQ96	T
AF22	PB93B	4	BDQ96	C
AG22	PB94A	4	BDQ96	T
VCCIO	VCCIO4	4		
AH22	PB94B	4	BDQ96	C
AG24	PB95A	4	BDQ96	T
AG23	PB95B	4	BDQ96	C
AE23	PB96A	4	BDQS96	
GND	GNDIO4	-		
AC22	PB97A	4	BDQ96	
AJ23	PB98A	4	BDQ96	T
VCCIO	VCCIO4	4		
AK23	PB98B	4	BDQ96	C
AD24	PB99A	4	BDQ96	T
AF24	PB99B	4	BDQ96	C
AC23	PB100A	4	VREF2_4/BDQ96	T
GND	GNDIO4	-		
AE24	PB100B	4	VREF1_4/BDQ96	C
AE25	CFG2	8		
AB22	CFG1	8		
AE26	CFG0	8		
AA22	PROGRAMN	8		
AD25	CCLK	8		
AD26	INITN	8		
AC24	DONE	8		
GND	GNDIO4	-		
AC25	PR90B	8	WRITEN	C
AE27	PR90A	8	CS1N	T
AC26	PR89B	8	CSN	C
AE28	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8		
AD27	PR88B	8	D1	C
AD28	PR88A	8	D2	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F14	PR24B	2	RDQ22	C (LVDS)*	PR34B	2	RDQ32	C(LVDS)*
F13	PR24A	2	RDQ22	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
GNDIO	GNDIO2	-			GNDIO2	-		
H11	PR14B	2		C	PR14B	2	RDQ15	C
G11	PR14A	2		T	PR14A	2	RDQ15	T
E13	PR13B	2		C (LVDS)*	PR13B	2	RDQ15	C(LVDS)*
F12	PR13A	2		T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
F11	PR12B	2	RUM0_SPLLC_FB_A	C	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C
E12	PR12A	2	RUM0_SPLLT_FB_A	T	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T
D16	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C(LVDS)*
D15	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
C16	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
B16	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
F4	XRES	-			XRES	-		
C15	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A14	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B15	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B14	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C12	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A11	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A12	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B11	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C11	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B10	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C10	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A10	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C14	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B13	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C13	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A13	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B9	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
D8	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D9	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C9	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A5	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
C5	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B5	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C4	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A8	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C8	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B8	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C7	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B7	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
A6	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D9	PT45A	0	VREF1_0	T
A2	PT44B	0		C
VCCIO	VCCIO0	0		
A3	PT44A	0		T
B3	PT43B	0		C
C4	PT43A	0		T
E10	PT42B	0		C
F10	PT42A	0		T
C7	PT41B	0		C
GNDIO	GNDIO0	-		
B6	PT41A	0		T
C6	PT40B	0		C
VCCIO	VCCIO0	0		
C5	PT40A	0		T
C8	PT39B	0		C
D8	PT39A	0		T
E8	PT38B	0		C
E9	PT38A	0		T
GNDIO	GNDIO0	-		
VCCIO	VCCIO0	0		
F8	PT10B	0		C
GNDIO	GNDIO0	-		
G8	PT10A	0		T
F7	PT9B	0		C
G7	PT9A	0		T
C3	PT8B	0		C
VCCIO	VCCIO0	0		
D4	PT8A	0		T
F6	PT7B	0		C
E6	PT7A	0		T
E5	PT6B	0		C
D6	PT6A	0		T
D3	PT5B	0		C
GNDIO	GNDIO0	-		
E3	PT5A	0		T
D5	PT4B	0		C
VCCIO	VCCIO0	0		
E4	PT4A	0		T
C2	PT3B	0		C
B2	PT3A	0		T
B1	PT2B	0		C
C1	PT2A	0		T
J10	VCC	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	GND	-		
L12	GND	-		
L13	GND	-		
M10	GND	-		
M11	GND	-		
M12	GND	-		
M13	GND	-		
N10	GND	-		
N11	GND	-		
N12	GND	-		
N13	GND	-		
N15	GND	-		
N20	GND	-		
N3	GND	-		
N8	GND	-		
P14	GND	-		
P9	GND	-		
R10	GND	-		
R13	GND	-		
T19	GND	-		
T4	GND	-		
W16	GND	-		
W2	GND	-		
W21	GND	-		
W7	GND	-		
Y10	GND	-		
Y13	GND	-		
Y15	NC	-		
W15	NC	-		
AB20	NC	-		
AB21	NC	-		
AA21	NC	-		
AA20	NC	-		
AB19	NC	-		
AB18	NC	-		
Y22	NC	-		
Y21	NC	-		
Y17	NC	-		
Y18	NC	-		
Y16	NC	-		
W17	NC	-		
Y19	NC	-		
Y20	NC	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F11	VCCIO0	0			VCCIO0	0			
J13	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	1			
D18	VCCIO1	1			VCCIO1	1			
F16	VCCIO1	1			VCCIO1	1			
J14	VCCIO1	1			VCCIO1	1			
K15	VCCIO1	1			VCCIO1	1			
G25	VCCIO2	2			VCCIO2	2			
L21	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M25	VCCIO2	2			VCCIO2	2			
N18	VCCIO2	2			VCCIO2	2			
P18	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R25	VCCIO3	3			VCCIO3	3			
T21	VCCIO3	3			VCCIO3	3			
Y25	VCCIO3	3			VCCIO3	3			
AA16	VCCIO4	4			VCCIO4	4			
AC18	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V14	VCCIO4	4			VCCIO4	4			
AA11	VCCIO5	5			VCCIO5	5			
V13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AE7	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
P9	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R2	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
Y2	VCCIO6	6			VCCIO6	6			
G2	VCCIO7	7			VCCIO7	7			
L6	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M2	VCCIO7	7			VCCIO7	7			
N9	VCCIO7	7			VCCIO7	7			
AC24	VCCIO8	8			VCCIO8	8			
U17	VCCIO8	8			VCCIO8	8			
J11	VCCAUX	-			VCCAUX	-			
J12	VCCAUX	-			VCCAUX	-			
J15	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
M18	VCCAUX	-			VCCAUX	-			
M9	VCCAUX	-			VCCAUX	-			
R18	VCCAUX	-			VCCAUX	-			
R9	VCCAUX	-			VCCAUX	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
J16	PT51B	1		C	PT60B	1			C
G15	PT51A	1		T	PT60A	1			T
GNDIO	GNDIO1	-			GNDIO1	-			
C16	PT50B	1		C	PT59B	1			C
D16	PT50A	1		T	PT59A	1			T
J15	PT49B	1		C	PT58B	1			C
H15	PT49A	1		T	PT58A	1			T
VCCIO	VCCIO1	1			VCCIO1	1			
A15	PT48B	1	VREF2_1	C	PT57B	1	VREF2_1		C
B15	PT48A	1	VREF1_1	T	PT57A	1	VREF1_1		T
F15	PT47B	1	PCLKC1_0	C	PT56B	1	PCLKC1_0		C
E16	PT47A	1	PCLKT1_0	T	PT56A	1	PCLKT1_0		T
C15	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0		C
GNDIO	GNDIO0	-			GNDIO0	-			
D15	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0		T
C14	PT45B	0	VREF2_0	C	PT54B	0	VREF2_0		C
E15	PT45A	0	VREF1_0	T	PT54A	0	VREF1_0		T
G14	PT44B	0		C	PT53B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
J14	PT44A	0		T	PT53A	0			T
F14	PT43B	0		C	PT52B	0			C
H14	PT43A	0		T	PT52A	0			T
A14	PT42B	0		C	PT51B	0			C
B14	PT42A	0		T	PT51A	0			T
D13	PT41B	0		C	PT50B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			
F13	PT41A	0		T	PT50A	0			T
G13	PT40B	0		C	PT49B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
J11	PT40A	0		T	PT49A	0			T
D4	PT38B	0		C	PT47B	0			C
D5	PT38A	0		T	PT47A	0			T
E5	PT37B	0		C	PT46B	0			C
F6	PT37A	0		T	PT46A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
F7	PT34B	0		C	PT43B	0			C
D8	PT34A	0		T	PT43A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
J13	PT32B	0		C	PT41B	0			C
G11	PT32A	0		T	PT41A	0			T
H13	PT31B	0		C	PT40B	0			C
H12	PT31A	0		T	PT40A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
E8	PT30B	0		C	PT39B	0			C
D9	PT30A	0		T	PT39A	0			T
D12	PT28B	0		C	PT37B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A9	ULC_SQ_HDOUTP0	11		T
A10	ULC_SQ_VCCOB0	11		
B9	ULC_SQ_HDOUTN0	11		C
C9	ULC_SQ_VCCTX1	11		
B8	ULC_SQ_HDOUTN1	11		C
C8	ULC_SQ_VCCOB1	11		
A8	ULC_SQ_HDOUTP1	11		T
C12	ULC_SQ_VCCRX1	11		
B11	ULC_SQ_HDINN1	11		C
C11	ULC_SQ_VCCIB1	11		
A11	ULC_SQ_HDINP1	11		T
B7	ULC_SQ_VCCAUX33	11		
E7	ULC_SQ_REFCLKN	11		C
D7	ULC_SQ_REFCLKP	11		T
C7	ULC_SQ_VCCP	11		
A3	ULC_SQ_HDINP2	11		T
C3	ULC_SQ_VCCIB2	11		
B3	ULC_SQ_HDINN2	11		C
C2	ULC_SQ_VCCRX2	11		
A6	ULC_SQ_HDOUTP2	11		T
C6	ULC_SQ_VCCOB2	11		
B6	ULC_SQ_HDOUTN2	11		C
C5	ULC_SQ_VCCTX2	11		
B5	ULC_SQ_HDOUTN3	11		C
A4	ULC_SQ_VCCOB3	11		
A5	ULC_SQ_HDOUTP3	11		T
C4	ULC_SQ_VCCTX3	11		
B2	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11		
A2	ULC_SQ_HDINP3	11		T
C1	ULC_SQ_VCCRX3	11		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
M11	VCC	-		
M12	VCC	-		
M13	VCC	-		
M14	VCC	-		
M15	VCC	-		
M16	VCC	-		
M17	VCC	-		
M18	VCC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K19	VCCIO1	1		
F28	VCCIO2	2		
J25	VCCIO2	2		
K28	VCCIO2	2		
M21	VCCIO2	2		
M24	VCCIO2	2		
N21	VCCIO2	2		
N28	VCCIO2	2		
P21	VCCIO2	2		
R25	VCCIO2	2		
AA28	VCCIO3	3		
AB25	VCCIO3	3		
AE28	VCCIO3	3		
T25	VCCIO3	3		
U21	VCCIO3	3		
V21	VCCIO3	3		
V28	VCCIO3	3		
W21	VCCIO3	3		
W24	VCCIO3	3		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AE19	VCCIO4	4		
AF22	VCCIO4	4		
AG17	VCCIO4	4		
AG25	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AE12	VCCIO5	5		
AF9	VCCIO5	5		
AG14	VCCIO5	5		
AG6	VCCIO5	5		
AA3	VCCIO6	6		
AB6	VCCIO6	6		
AE3	VCCIO6	6		
T6	VCCIO6	6		
U10	VCCIO6	6		
V10	VCCIO6	6		
V3	VCCIO6	6		
W10	VCCIO6	6		
W7	VCCIO6	6		
F3	VCCIO7	7		
J6	VCCIO7	7		
K3	VCCIO7	7		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
P31	NC	-			PR39B	2		C (LVDS)*
P32	NC	-			PR39A	2		T (LVDS)*
R25	NC	-			PR38B	2		C
-	-	-			VCCIO2	2		
T24	NC	-			PR38A	2		T
N34	NC	-			PR37B	2		C (LVDS)*
N33	NC	-			PR37A	2		T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
M34	PR31B	2	RDQ28	C	PR35B	2	RDQ32	C
M33	PR31A	2	RDQ28	T	PR35A	2	RDQ32	T
-	-	-			GNDIO2	-		
R24	PR30B	2	RDQ28	C (LVDS)*	PR34B	2	RDQ32	C (LVDS)*
P24	PR30A	2	RDQ28	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
N30	PR29B	2	RDQ28	C	PR33B	2	RDQ32	C
M29	PR29A	2	RDQ28	T	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2			VCCIO2	2		
N28	PR28B	2	RDQ28	C (LVDS)*	PR32B	2	RDQ32	C (LVDS)*
N29	PR28A	2	RDQS28	T (LVDS)*	PR32A	2	RDQS32	T (LVDS)*
N24	PR27B	2	RDQ28	C	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-			GNDIO2	-		
N25	PR27A	2	RDQ28	T	PR31A	2	RDQ32	T
M28	PR26B	2	RDQ28	C (LVDS)*	PR30B	2	RDQ32	C (LVDS)*
M27	PR26A	2	RDQ28	T (LVDS)*	PR30A	2	RDQ32	T (LVDS)*
L27	PR25B	2	RDQ28	C	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2			VCCIO2	2		
M26	PR25A	2	RDQ28	T	PR29A	2	RDQ32	T
M32	PR24B	2	RDQ28	C (LVDS)*	PR28B	2	RDQ32	C (LVDS)*
M31	PR24A	2	RDQ28	T (LVDS)*	PR28A	2	RDQ32	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
-	-	-			VCCIO2	2		
L34	PR22B	2		C	PR22B	2	RDQ23	C
L33	PR22A	2		T	PR22A	2	RDQ23	T
L32	PR21B	2		C (LVDS)*	PR21B	2	RDQ23	C (LVDS)*
L31	PR21A	2		T (LVDS)*	PR21A	2	RDQ23	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
L28	PR20B	2		C	PR20B	2	RDQ23	C
L29	PR20A	2		T	PR20A	2	RDQ23	T
M30	PR19B	2		C (LVDS)*	PR19B	2	RDQ23	C (LVDS)*
L30	PR19A	2		T (LVDS)*	PR19A	2	RDQ23	T (LVDS)*
K34	PR18B	2	RDQ15	C	PR18B	2	RDQ15	C
K33	PR18A	2	RDQ15	T	PR18A	2	RDQ15	T
GNDIO	GNDIO2	-			GNDIO2	-		
K30	PR17B	2	RDQ15	C (LVDS)*	PR17B	2	RDQ15	C (LVDS)*
K29	PR17A	2	RDQ15	T (LVDS)*	PR17A	2	RDQ15	T (LVDS)*
J34	PR16B	2	RDQ15	C	PR16B	2	RDQ15	C
J33	PR16A	2	RDQ15	T	PR16A	2	RDQ15	T
VCCIO	VCCIO2	2			VCCIO2	2		
J32	PR15B	2	RDQ15	C (LVDS)*	PR15B	2	RDQ15	C (LVDS)*
J31	PR15A	2	RDQS15	T (LVDS)*	PR15A	2	RDQS15	T (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO0	-			GNDIO0	-		
G15	PT41A	0		T	PT46A	0		T
J14	NC	-			PT45B	0		C
L15	NC	-			PT45A	0		T
H14	NC	-			PT44B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
K14	NC	-			PT44A	0		T
F15	PT38B	0		C	PT42B	0		C
G14	PT38A	0		T	PT42A	0		T
C15	PT37B	0		C	PT41B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
D14	PT37A	0		T	PT41A	0		T
G13	PT36B	0		C	PT40B	0		C
-	-	-			VCCIO0	0		
J13	PT36A	0		T	PT40A	0		T
B14	PT35B	0		C	PT39B	0		C
VCCIO	VCCIO0	0			-	-		
A14	PT35A	0		T	PT39A	0		T
F13	PT34B	0		C	PT38B	0		C
H13	PT34A	0		T	PT38A	0		T
D13	PT33B	0		C	PT37B	0		C
C14	PT33A	0		T	PT37A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
E13	PT32B	0		C	PT32B	0		C
D12	PT32A	0		T	PT32A	0		T
G12	PT31B	0		C	PT31B	0		C
E12	PT31A	0		T	PT31A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F12	NC	-			PT30B	0		C
D11	NC	-			PT30A	0		T
F11	NC	-			PT29B	0		C
E11	NC	-			PT29A	0		T
D7	ULC_SQ_VCCRX0	11			ULC_SQ_VCCRX0	11		
C9	ULC_SQ_HDINP0	11		T	ULC_SQ_HDINP0	11		T
B9	ULC_SQ_VCCIB0	11			ULC_SQ_VCCIB0	11		
C8	ULC_SQ_HDINN0	11		C	ULC_SQ_HDINN0	11		C
B8	ULC_SQ_VCCTX0	11			ULC_SQ_VCCTX0	11		
A9	ULC_SQ_HDOUTP0	11		T	ULC_SQ_HDOUTP0	11		T
D9	ULC_SQ_VCCOB0	11			ULC_SQ_VCCOB0	11		
A8	ULC_SQ_HDOUTN0	11		C	ULC_SQ_HDOUTN0	11		C
B7	ULC_SQ_VCCTX1	11			ULC_SQ_VCCTX1	11		
A7	ULC_SQ_HDOUTN1	11		C	ULC_SQ_HDOUTN1	11		C
E7	ULC_SQ_VCCOB1	11			ULC_SQ_VCCOB1	11		
A6	ULC_SQ_HDOUTP1	11		T	ULC_SQ_HDOUTP1	11		T
B6	ULC_SQ_VCCRX1	11			ULC_SQ_VCCRX1	11		
C7	ULC_SQ_HDINN1	11		C	ULC_SQ_HDINN1	11		C
D8	ULC_SQ_VCCIB1	11			ULC_SQ_VCCIB1	11		
C6	ULC_SQ_HDINP1	11		T	ULC_SQ_HDINP1	11		T
E6	ULC_SQ_VCCAUX33	11			ULC_SQ_VCCAUX33	11		



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484C	331	1.2V	-5	fpBGA	484	COM	35
LFE2-35E-6F484C	331	1.2V	-6	fpBGA	484	COM	35
LFE2-35E-7F484C	331	1.2V	-7	fpBGA	484	COM	35
LFE2-35E-5F672C	450	1.2V	-5	fpBGA	672	COM	35
LFE2-35E-6F672C	450	1.2V	-6	fpBGA	672	COM	35
LFE2-35E-7F672C	450	1.2V	-7	fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484C	339	1.2V	-5	fpBGA	484	COM	50
LFE2-50E-6F484C	339	1.2V	-6	fpBGA	484	COM	50
LFE2-50E-7F484C	339	1.2V	-7	fpBGA	484	COM	50
LFE2-50E-5F672C	500	1.2V	-5	fpBGA	672	COM	50
LFE2-50E-6F672C	500	1.2V	-6	fpBGA	672	COM	50
LFE2-50E-7F672C	500	1.2V	-7	fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672C	500	1.2V	-5	fpBGA	672	COM	70
LFE2-70E-6F672C	500	1.2V	-6	fpBGA	672	COM	70
LFE2-70E-7F672C	500	1.2V	-7	fpBGA	672	COM	70
LFE2-70E-5F900C	583	1.2V	-5	fpBGA	900	COM	70
LFE2-70E-6F900C	583	1.2V	-6	fpBGA	900	COM	70
LFE2-70E-7F900C	583	1.2V	-7	fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144I	90	1.2V	-5	TQFP	144	IND	6
LFE2-6E-6T144I	90	1.2V	-6	TQFP	144	IND	6
LFE2-6E-5F256I	190	1.2V	-5	fpBGA	256	IND	6
LFE2-6E-6F256I	190	1.2V	-6	fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144I	93	1.2V	-5	TQFP	144	IND	12
LFE2-12E-6T144I	93	1.2V	-6	TQFP	144	IND	12
LFE2-12E-5Q208I	131	1.2V	-5	PQFP	208	IND	12
LFE2-12E-6Q208I	131	1.2V	-6	PQFP	208	IND	12
LFE2-12E-5F256I	193	1.2V	-5	fpBGA	256	IND	12
LFE2-12E-6F256I	193	1.2V	-6	fpBGA	256	IND	12
LFE2-12E-5F484I	297	1.2V	-5	fpBGA	484	IND	12
LFE2-12E-6F484I	297	1.2V	-6	fpBGA	484	IND	12



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208I	131	1.2V	-5	PQFP	208	IND	20
LFE2-20E-6Q208I	131	1.2V	-6	PQFP	208	IND	20
LFE2-20E-5F256I	193	1.2V	-5	fpBGA	256	IND	20
LFE2-20E-6F256I	193	1.2V	-6	fpBGA	256	IND	20
LFE2-20E-5F484I	331	1.2V	-5	fpBGA	484	IND	20
LFE2-20E-6F484I	331	1.2V	-6	fpBGA	484	IND	20
LFE2-20E-5F672I	402	1.2V	-5	fpBGA	672	IND	20
LFE2-20E-6F672I	402	1.2V	-6	fpBGA	672	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484I	331	1.2V	-5	fpBGA	484	IND	35
LFE2-35E-6F484I	331	1.2V	-6	fpBGA	484	IND	35
LFE2-35E-5F672I	450	1.2V	-5	fpBGA	672	IND	35
LFE2-35E-6F672I	450	1.2V	-6	fpBGA	672	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484I	339	1.2V	-5	fpBGA	484	IND	50
LFE2-50E-6F484I	339	1.2V	-6	fpBGA	484	IND	50
LFE2-50E-5F672I	500	1.2V	-5	fpBGA	672	IND	50
LFE2-50E-6F672I	500	1.2V	-6	fpBGA	672	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672I	500	1.2V	-5	fpBGA	672	IND	70
LFE2-70E-6F672I	500	1.2V	-6	fpBGA	672	IND	70
LFE2-70E-5F900I	583	1.2V	-5	fpBGA	900	IND	70
LFE2-70E-6F900I	583	1.2V	-6	fpBGA	900	IND	70



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5F484C	331	1.2V	-5	fpBGA	484	Com	35
LFE2-35SE-6F484C	331	1.2V	-6	fpBGA	484	Com	35
LFE2-35SE-7F484C	331	1.2V	-7	fpBGA	484	Com	35
LFE2-35SE-5F672C	450	1.2V	-5	fpBGA	672	Com	35
LFE2-35SE-6F672C	450	1.2V	-6	fpBGA	672	Com	35
LFE2-35SE-7F672C	450	1.2V	-7	fpBGA	672	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5F484C	339	1.2V	-5	fpBGA	484	Com	50
LFE2-50SE-6F484C	339	1.2V	-6	fpBGA	484	Com	50
LFE2-50SE-7F484C	339	1.2V	-7	fpBGA	484	Com	50
LFE2-50SE-5F672C	500	1.2V	-5	fpBGA	672	Com	50
LFE2-50SE-6F672C	500	1.2V	-6	fpBGA	672	Com	50
LFE2-50SE-7F672C	500	1.2V	-7	fpBGA	672	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5F672C	500	1.2V	-5	fpBGA	672	Com	70
LFE2-70SE-6F672C	500	1.2V	-6	fpBGA	672	Com	70
LFE2-70SE-7F672C	500	1.2V	-7	fpBGA	672	Com	70
LFE2-70SE-5F900C	583	1.2V	-5	fpBGA	900	Com	70
LFE2-70SE-6F900C	583	1.2V	-6	fpBGA	900	Com	70
LFE2-70SE-7F900C	583	1.2V	-7	fpBGA	900	Com	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5T144I	90	1.2V	-5	TQFP	144	Ind	6
LFE2-6SE-6T144I	90	1.2V	-6	TQFP	144	Ind	6
LFE2-6SE-5F256I	190	1.2V	-5	fpBGA	256	Ind	6
LFE2-6SE-6F256I	190	1.2V	-6	fpBGA	256	Ind	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5T144I	93	1.2V	-5	TQFP	144	Ind	12
LFE2-12SE-6T144I	93	1.2V	-6	TQFP	144	Ind	12
LFE2-12SE-5Q208I	131	1.2V	-5	PQFP	208	Ind	12
LFE2-12SE-6Q208I	131	1.2V	-6	PQFP	208	Ind	12
LFE2-12SE-5F256I	193	1.2V	-5	fpBGA	256	Ind	12
LFE2-12SE-6F256I	193	1.2V	-6	fpBGA	256	Ind	12
LFE2-12SE-5F484I	297	1.2V	-5	fpBGA	484	Ind	12
LFE2-12SE-6F484I	297	1.2V	-6	fpBGA	484	Ind	12